MINMIN HOU

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EDUCATION

Stanford University Ph.D. in Electrical Engineering Overall GPA: 3.8/4.0Areas: Sensors, Analog Front End, Signal Processing

Stanford University M.S. in Electrical Engineering

Tianjin University B.Eng. in Electrical & Automation Engineering

WORK EXPERIENCE

Fitbit Inc. Research Scientist Intern, Sensors & Algorithm

· Investigated feasibility of a new sensing technology

- · Designed and prototyped analog front end (AFE) for the new sensor
- · Developed and improved signal processing algorithm for a new application

Apple Inc.

Sensing System Intern

- · Wrote Python programs for controlling instruments, performing tests, and processing test data
- Conducted characterization tests for sensor modules
- Conducted thermal and structural finite element analysis for new sensors

LEADERSHIP ROLES

Teaching Assistant

- EE204 Business Management for EE & CS
- · Interviewed previous EE204 online students and identified areas for course improvement
- · Prioritized new features to add to the course online learning platform
- · Worked with Product Develop team of Stanford Center for Professional Development (SCPD) to develop, iterate, test and launch the new features
- Coordinated with SCPD to solve the unforeseen issues encountered by students after initial launch

Program Lead

Stanford XLab Mega Run

- Made program schedule and identified risks with the program team (researchers in Stanford XLab)
- · Coordinated initiatives to mitigate risks in the early stage of the program
- \cdot Coordinated 8 researchers in the design and mask layout of 10+ types of MEMS sensors (Mega Run)
- · Led a 4-person team in cleanroom micro-fabrication, assigned tasks and made sure progress was made per schedule
- · Solved unforeseen issues with the team, adjusted schedule and managed expectations during the course of program

SELECTED PROJECTS

PhD Research: Galllium Nitride MEMS Sensors

Adviser: D.G. Senesky

- · Designed and modeled gallium nitride (GaN) MEMS for chemical and UV sensing at high temperatures
- · Developed micro-fabrication process modules for GaN MEMS sensors
- · Investigated the high-temperature reliability of GaN heterostructure and metallization
- · Conducted electrical testing and optical characterization of fabricated devices

Expected Summer 2017

June 2014

June 2012

June - September 2016 San Francisco, CA

June - September 2015 Cupertino, CA

> March - June 2016 Stanford, CA

March - September 2014 Stanford, CA

November 2013 - Present

Analog Front End Prototyping

EE122B Intro Biomedical Electronics

- \cdot Conceived specs for an Arduino shield for biosignals with the project team (analog, power, wireless, firmware)
- $\cdot\,$ Designed analog circuits for signal acquisition and conditioning of ECG (electrocardiogram) and ICG (impedance cardiogram)
- $\cdot\,$ Prototyped and debugged the analog circuits

UX Design: Improving Interactivity in College Classes CS147 Intro HCI Design

- · Interviewed college students and conducted need-finding analysis
- \cdot Formed points of view and brainstormed solutions
- · Created prototypes and conducted user testing

Business Strategy Recommendations to Microsoft

EE204 Business Management for EE & CS

- · Analyzed Microsoft's various businesses (the market shares, annual growth rates, contributions to revenue, and ecosystems)
- $\cdot\,$ Analyzed the global mobile & cloud computing markets and the potential growth spaces for Microsoft
- · Recommended business strategies to Microsoft (top paper of the class)
- · Estimated Microsoft's revenue evolution based on the strategy recommendations

TECHNICAL SKILLS

Programming Sensors Analog Front End Signal Processing Data Science Finite Element Modeling Micro-Fabrication Material Characterization Circuit Design & Simulation	 Python, R, MATLAB, C++ Design, Modeling, Fabrication, Testing Design, Prototyping, Debugging Preprocessing, Feature Selection, Regression, Classification Supervised & Unsupervised Machine Learning Techniques ANSYS, COMSOL Photolithography, CVD, ALD, E-Beam Evaporation, Dry Etch, Wet Etch SEM, AFM, XPS, AES (Auger Electron Spectroscopy) LTSpice, Cadence
Material Characterization	SEM, AFM, XPS, AES (Auger Electron Spectroscopy)
Circuit Design & Simulation	LTSpice, Cadence
Mask Layout	L-Edit
PCB Layout	Eagle CAD

SELECTED PUBLICATIONS

Journal Articles

- <u>M. Hou</u>, D. G. Senesky, "Operation of ohmic Ti/Al/Pt/Au multilayer contacts to GaN at 600C in air", Appl. Phys. Lett., 105, 081905, August 2014.
- · <u>M. Hou</u>, H. So, A.J. Suria, A.S. Yalamarthy, D.G. Senesky, "Suppression of Persistent Photoconductivity in AlGaN/GaN Ultraviolet Photodetectors Using In-Situ Heating", submitted for review.

Conference Proceedings

- <u>M. Hou</u>, A.J. Suria, A.S. Yalamarthy, H. So, D.G. Senesky, "2DEG-Heated AlGaN/GaN Micro-Hotplates for High-Temperature Chemical Sensing Microsystems", in Proc. Solid-State Sensors, Actuators and Microsystems Workshop 2016, Hilton Head SC, June 2016.
- <u>M. Hou</u>, C. Pan, M. Asheghi, D. G. Senesky, "Finite element thermal analysis of localized heating of AlGaN/GaN HEMT based sensors", *in Proc. IEEE ITherm Conference 2014*, Orlando FL, May 2014.

September - December 2015 Teacher: J. Landay

> May 2015 Teacher: F. Gibbons

May - June 2016 Teachers: G. Kovacs, L. Giovangrandi